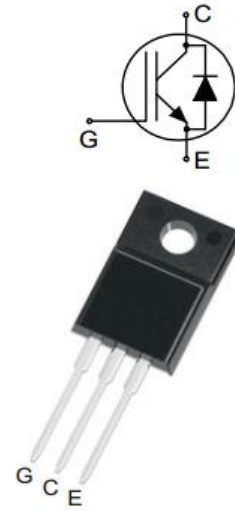


IGBT Features

- 650V,20A
- $V_{CE(sat)(typ.)}=2.1V@V_{GE}=15V,I_C=20A$
- High speed switching
- Higher system efficiency
- Soft current turn-off waveforms
- Square RBSOA

General Description

JIAEN trench FS IGBTs offer lower losses, higher energy efficiency and short circuit robustness for application such as motor control, uninterrupted power supplies, inverters and home applications.



Absolute Maximum Ratings

Symbol	Parameter	Value	Units
V_{CES}	Collector-Emitter Voltage	650	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_C	Continuous Collector Current ($T_C=25^\circ C$)	40	A
	Continuous Collector Current ($T_C=100^\circ C$)	20	A
I_{CM}	Pulsed Collector Current (Note 1)	40	A
I_F	Diode Continuous Forward Current ($T_C=100^\circ C$)	10	A
I_{FM}	Diode Maximum Forward Current (Note 1)	40	A
t_{sc}	Short Circuit Withstand Time	5	us
P_D	Maximum Power Dissipation ($T_C=25^\circ C$)	40	W
	Maximum Power Dissipation ($T_C=100^\circ C$)	15	W
T_J	Operating Junction Temperature Range	-55 to +150	$^\circ C$
T_{STG}	Storage Temperature Range	-55 to +150	$^\circ C$

Thermal Characteristics

Symbol	Parameter	Max.	Units
$R_{th\ j-c}$	Thermal Resistance, Junction to case for IGBT	3.0	$^\circ C/W$
$R_{th\ j-c}$	Thermal Resistance, Junction to case for Diode	4.2	$^\circ C/W$
$R_{th\ j-a}$	Thermal Resistance, Junction to Ambient	65	$^\circ C/W$

Electrical Characteristics ($T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{CES}	Collector-Emitter Breakdown Voltage	$V_{GE}=0V, I_C=250\mu A$	650	-	-	V
I_{CES}	Collector-Emitter Leakage Current	$V_{CE}=650V, V_{GE}=0V$	-	-	100	μA
I_{GES}	Gate Leakage Current, Forward	$V_{GE}=20V, V_{CE}=0V$	-	-	100	nA
	Gate Leakage Current, Reverse	$V_{GE}=-20V, V_{CE}=0V$	-	-	-100	nA
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE}=V_{CE}, I_C=250\mu A$	4.0	-	5.2	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$V_{GE}=15V, I_C=15A$	-	1.65	1.95	V
		$V_{GE}=15V, I_C=20A$	-	2.1	2.4	V
Q_g	Total Gate Charge	$V_{CC}=400V$	-	29	-	nC
Q_{ge}	Gate-Emitter Charge	$V_{GE}=15V$	-	6	-	nC
Q_{gc}	Gate-Collector Charge	$I_C=15A$	-	9	-	nC
$t_{d(on)}$	Turn-on Delay Time	$V_{CC}=400V$ $V_{GE}=15V$ $I_C=15A$ $R_{Gon}=39\Omega$ $R_{Goff}=22\Omega$ Inductive Load $T_C=25^\circ\text{C}$	-	40	-	ns
t_r	Turn-on Rise Time		-	22	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	98	-	ns
t_f	Turn-off Fall Time		-	107	-	ns
E_{on}	Turn-on Switching Loss		-	0.24	-	mJ
E_{off}	Turn-off Switching Loss		-	0.66	-	mJ
E_{ts}	Total Switching Loss		-	0.9	-	mJ
C_{ies}	Input Capacitance	$V_{CE}=25V$	-	886	-	pF
C_{oes}	Output Capacitance	$V_{GE}=0V$	-	52	-	pF
C_{res}	Reverse Transfer Capacitance	$f=1\text{MHz}$	-	15	-	pF

Electrical Characteristics of Diode ($T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_F	Diode Forward Voltage	$I_F=15A$	-	1.4	1.8	V
t_{rr}	Diode Reverse Recovery Time	$V_{CE}=400V$	-	126	-	ns
I_{rr}	Diode peak Reverse Recovery Current	$I_F=15A$	-	5.5	-	A
Q_{rr}	Diode Reverse Recovery Charge	$dI_F/dt=200A/\mu s$	-	296	-	nC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature

Typical Performance Characteristics

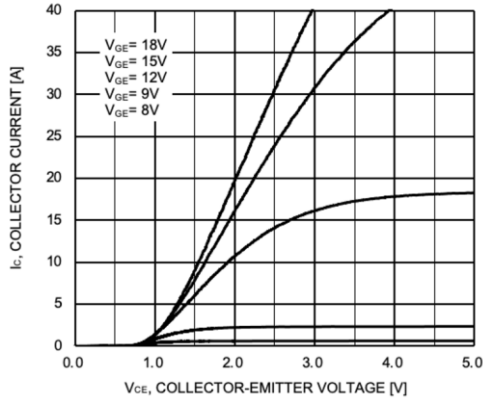


Fig 1. Output characteristics ($T_j=25^{\circ}\text{C}$)

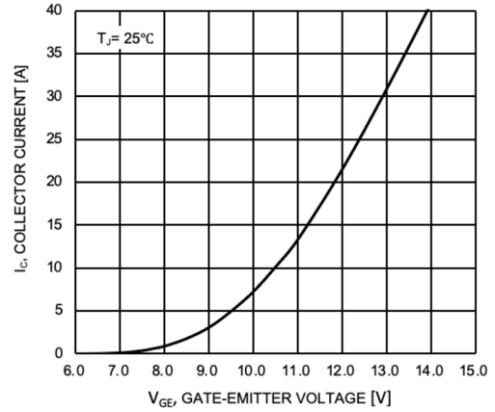


Fig 2. Typical Transfer Characteristics ($T_j=25^{\circ}\text{C}$)

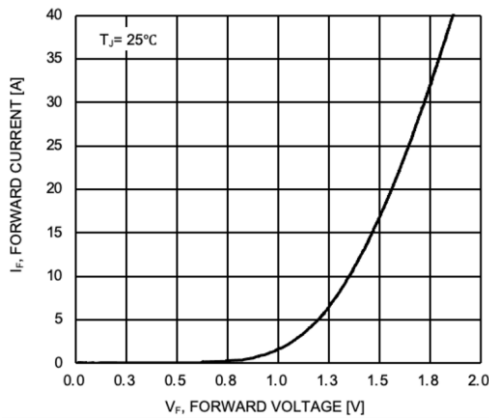


Figure 3. Typical FRD Output characteristics ($T_j=25^{\circ}\text{C}$)

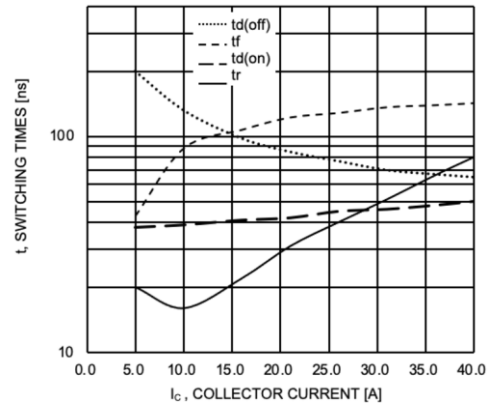


Figure 4. Typical Switching Time vs. Collector Current ($T_j=25^{\circ}\text{C}$)

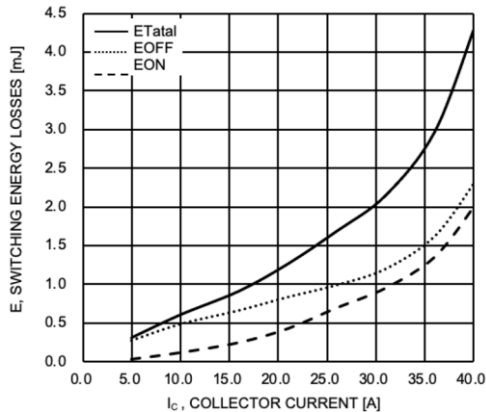


Figure 5. Typical Switching Loss vs. Collector Current ($T_j=25^{\circ}\text{C}$)

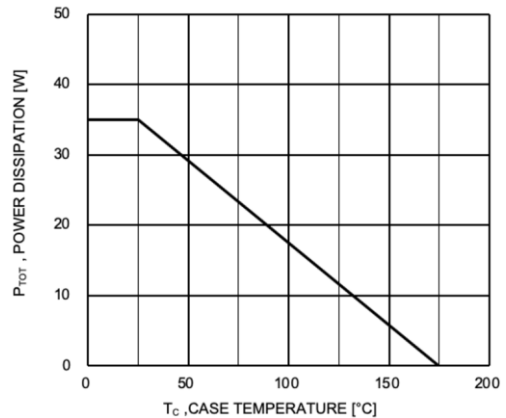


Figure 6. Typical Power Dissipation vs. Case Temperature (TO220F)

Typical Performance Characteristics

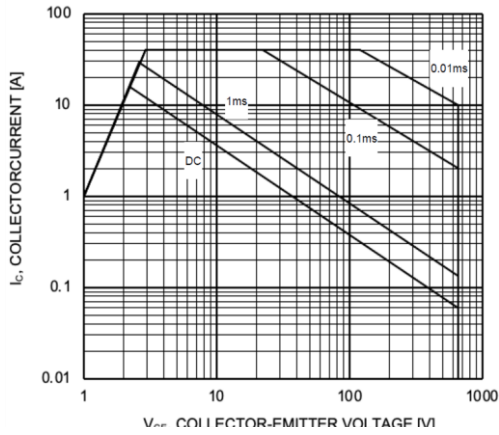
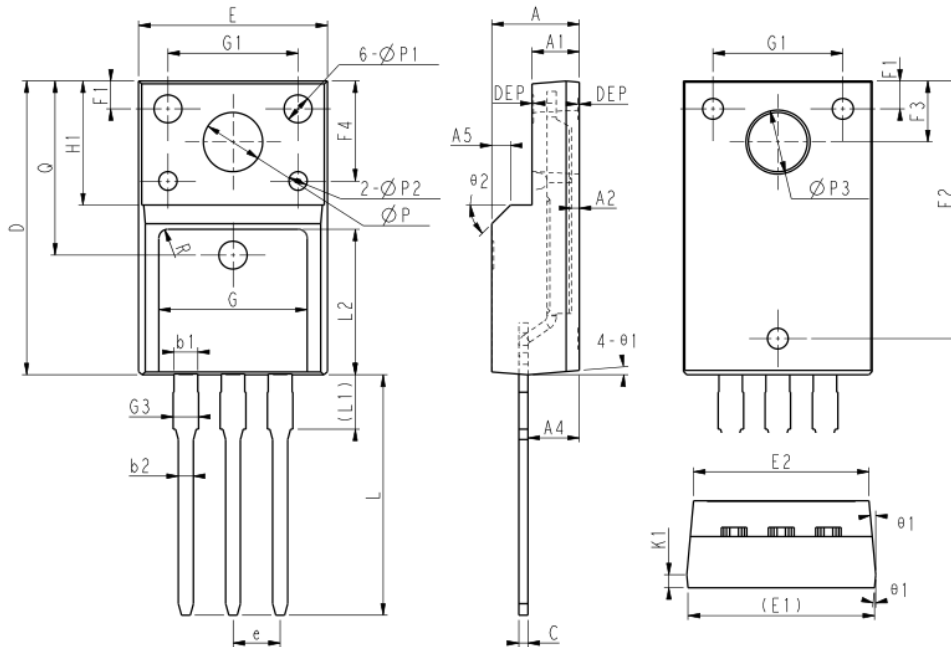


Figure 7. Forward Safe Operation Area vs. Applied Collector Current (TO220F, T_J=25°C)

Package



COMMON DIMENSIONS

SYMBOL	MM		
	MIN	NOM	MAX
E	10.00	10.16	10.32
E1	9.94	10.04	10.14
E2	9.36	9.46	9.56
A	4.50	4.70	4.90
A1	2.34	2.54	2.74
A2	0.43	-	0.48
A4	2.66	2.76	2.86
A5	1.00REF		
c	0.45	0.50	0.60
D	15.67	15.87	16.07
Q	9.40REF		
H1	6.70REF		
e	2.54BSC		
ΦP	3.18REF		
L	12.78	12.98	13.18
L1	2.83	2.93	3.03
L2	7.70	7.80	7.90
ΦP1	1.40	1.50	1.60
ΦP2	0.95	1.00	1.05
ΦP3	3.45REF		
θ1	3°	5°	7°
θ2	-	45°	-
DEP	0.05	0.10	0.15
F1	1.00	1.50	2.00
F2	13.80	13.90	14.00
F3	3.20	3.30	3.40
F4	5.30	5.40	5.50
G	7.80	8.00	8.20
G1	6.90	7.00	7.10
G3	1.25	1.35	1.45
b1	1.23	1.28	1.38
b2	0.75	0.80	0.90
K1	0.65	0.70	0.75
R	0.50REF		

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